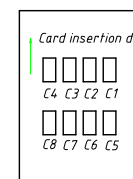


Contact position description



Chip up according to ISO7816 representation

Material:

Base: Hi-temp Thermoplastic, Black UL 94V-0

Cover: SUS, Solder area: Tin plated

Data Contact: Copper Alloy, Contact area: Gold plated

Current Rating: 1A

Contact Resistance: 50mΩ typical, 100mΩ max.

Insulation Resistance: 1000MΩ min

Dielectric withstanding voltage: AC 500V(r.m.s) /60s

Durability: 100,000 cycles min.

Operating temperature: -40°C ~ +85°C

Product temperature resistance: 260±5°C 10S

GENERAL TOLERANCE		ANGLE TOLERANCE		PROJECTION		Description:
X	±0.15	X	±5°	UNITS	mm	Smart Card Connector
.X	±0.03	.X	±3°	SHEET SIZE	A4	
.XX	±0.05	.XX	±2°		KLS P/N:	L-KLS1-ISC-F008B
Draw by:	Jenny	Date:	2018-11-01	NingBo KLS ELECTRONIC CO.,LTD.		
Check by:		Date:				
SCALE		SHEET	1 OF 1			